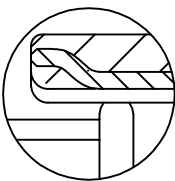
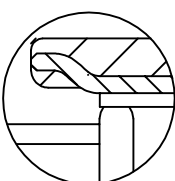
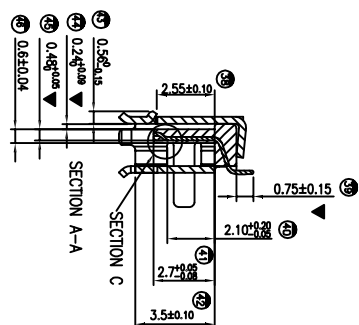
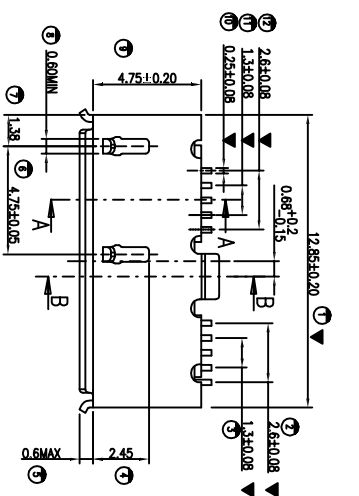
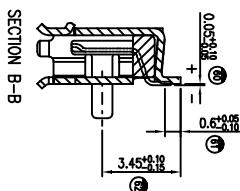
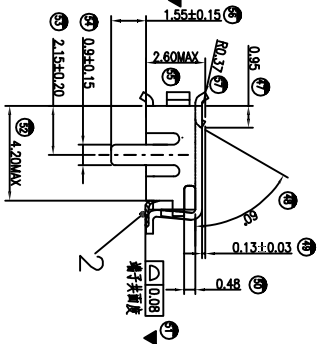
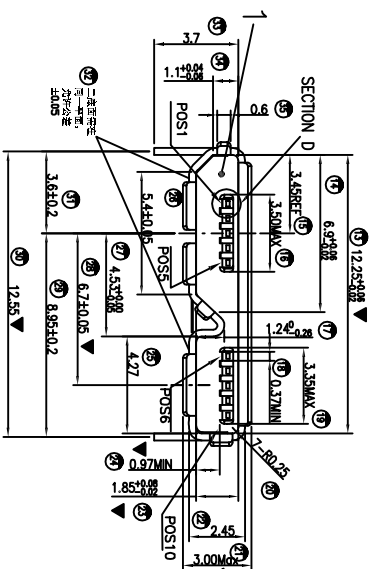


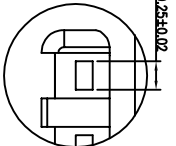
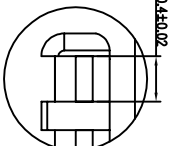
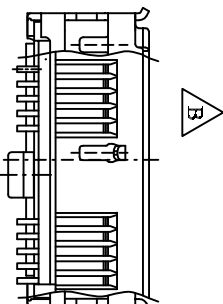
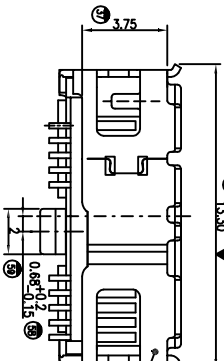
目録 MAPX	設定内容 MODIFICATION	日期 DATE
A0	NEW	09-10-20



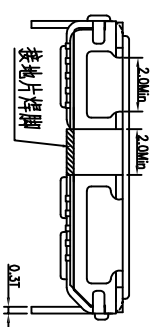
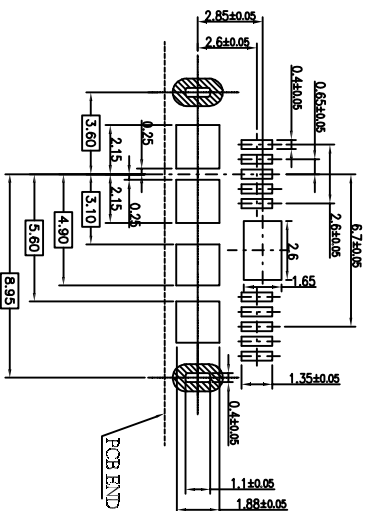
SECTION C Scale 5:1



SECTION B-B



SECTION D Scale 5:1



4.1 TERMINAL: 150" GOLD FLASH ALL OVER 500" MIN NICKEL AND 1000" MIN Tin ALL OVER 500" MIN NICKEL ON SOLDER AREA

4.2 SHELL: 500" MIN. NICKEL OVER 20" MIN COPPER

4. PLATING

3.1 MATING FORCE:3.57kg MAX
3.2 UNMATED FORCE:1.02kg MIN

3 MECHANICAL CHARACTERISTICS:

2.5 OPERATING TEMPERATURE: $-0^{\circ}\text{C} \sim 50^{\circ}\text{C}$

2.4 INSULATION RESISTANCE 100MΩ MIN INITIAL

2.3 DIELECTRIC WITHSTANDING VOLTAGE:100 V R.M.S

2.2 CONTACT CURRENT RATING:1.5A

2. ELECTRICAL CHARACTERISTICS,
2.1 CONTACT RATING: 30 VAC.

1.3 SHELL:305-304(1=0.30mm)

1.2 CONIAC1.FIU.Brillse(1=U.13mm,
1.3 CHEI1.CIIC 304(T=0 30mm)

1.1 INSULATION LCP 34V=0
1.2 CONTACT:Phs Pressure(T=0.1

1.1. MATERIAL:

NOTE:
1 MATERIAL

NOTES

Pin	SIGNAL
NUMBER	NAME
1	V _{BUS}
2	D-
3	D+
4	TD
5	GND
6	MICA_SSTX-
7	MICA_SSTX+
8	GND_DRAIN
9	MICA_SSRX-
10	MICA_SSRX+
Shell	Shield

产品图 PRODUCT CHART DWG				深圳市鑫风雷电子有限公司			
公差一览表 TOLERANCE UNLESS OTHERWISE				单位 UNITS		MM	
X	±0.30	X.	±5	制图 DRAWING		王冠	
.X	±0.25	.X'	±2	审核 CHECK		雷永健	
.XX	±0.30	.XX'	±1	比例 SCALE		1:1	
.XXX	±0.15	.XXX'	±0.5	日期 DATE		2009/10/20	
				核准 APP		雷永健	
				角法 ANGLE			
				版本 VER		A0	
				产品料号 PRODUCT PART NO		17004-U3MF001-X	
				产品名称 PRODUCT NAME		USB 3.0 Micro Standard B TYPE DTP带接地片	